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## Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

## Applications of Embedded - CPLDs

### Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	2.7 ns
Voltage Supply - Internal	2.3V ~ 2.7V
Number of Logic Elements/Blocks	8
Number of Macrocells	128
Number of Gates	-
Number of I/O	64
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4128b-27t100c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4128b-27t100c</a>

- Block CLK2
- Block CLK3
- PT Clock
- PT Clock Inverted
- Shared PT Clock
- Ground

### Clock Enable Multiplexer

Each macrocell has a 4:1 clock enable multiplexer. This allows the clock enable signal to be selected from the following four sources:

- PT Initialization/CE
- PT Initialization/CE Inverted
- Shared PT Clock
- Logic High

### Initialization Control

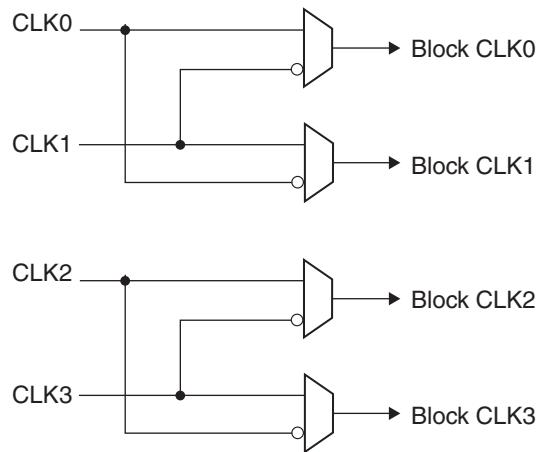
The ispMACH 4000 family architecture accommodates both block-level and macrocell-level set and reset capability. There is one block-level initialization term that is distributed to all macrocell registers in a GLB. At the macrocell level, two product terms can be “stolen” from the cluster associated with a macrocell to be used for set/reset functionality. A reset/preset swapping feature in each macrocell allows for reset and preset to be exchanged, providing flexibility.

Note that the reset/preset swapping selection feature affects power-up reset as well. All flip-flops power up to a known state for predictable system initialization. If a macrocell is configured to SET on a signal from the block-level initialization, then that macrocell will be SET during device power-up. If a macrocell is configured to RESET on a signal from the block-level initialization or is not configured for set/reset, then that macrocell will RESET on power-up. To guarantee initialization values, the  $V_{CC}$  rise must be monotonic, and the clock must be inactive until the reset delay time has elapsed.

### GLB Clock Generator

Each ispMACH 4000 device has up to four clock pins that are also routed to the GRP to be used as inputs. These pins drive a clock generator in each GLB, as shown in Figure 6. The clock generator provides four clock signals that can be used anywhere in the GLB. These four GLB clock signals can consist of a number of combinations of the true and complement edges of the global clock signals.

**Figure 6. GLB Clock Generator**



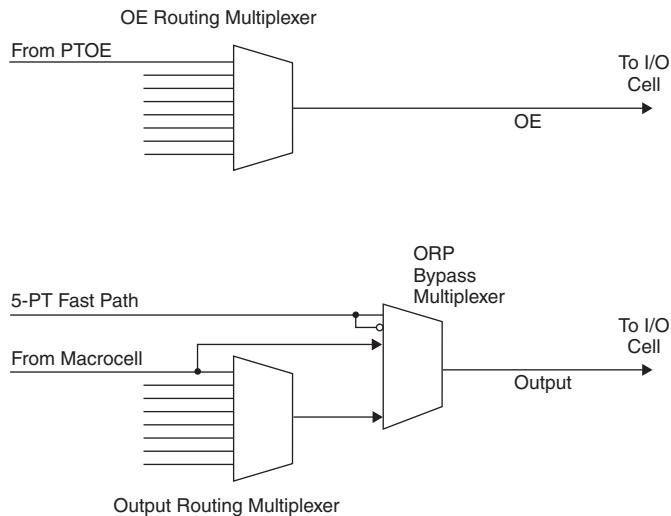
## Output Routing Pool (ORP)

The Output Routing Pool allows macrocell outputs to be connected to any of several I/O cells within an I/O block. This provides greater flexibility in determining the pinout and allows design changes to occur without affecting the pinout. The output routing pool also provides a parallel capability for routing macrocell-level OE product terms. This allows the OE product term to follow the macrocell output as it is switched between I/O cells. Additionally, the output routing pool allows the macrocell output or true and complement forms of the 5-PT bypass signal to bypass the output routing multiplexers and feed the I/O cell directly. The enhanced ORP of the ispMACH 4000 family consists of the following elements:

- Output Routing Multiplexers
- OE Routing Multiplexers
- Output Routing Pool Bypass Multiplexers

Figure 7 shows the structure of the ORP from the I/O cell perspective. This is referred to as an ORP slice. Each ORP has as many ORP slices as there are I/O cells in the corresponding I/O block.

**Figure 7. ORP Slice**



## Output Routing Multiplexers

The details of connections between the macrocells and the I/O cells vary across devices and within a device dependent on the maximum number of I/Os available. Tables 5-9 provide the connection details.

**Table 6. ORP Combinations for I/O Blocks with 8 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M2, M3, M4, M5, M6, M7, M8, M9
I/O 2	M4, M5, M6, M7, M8, M9, M10, M11
I/O 3	M6, M7, M8, M9, M10, M11, M12, M13
I/O 4	M8, M9, M10, M11, M12, M13, M14, M15
I/O 5	M10, M11, M12, M13, M14, M15, M0, M1
I/O 6	M12, M13, M14, M15, M0, M1, M2, M3
I/O 7	M14, M15, M0, M1, M2, M3, M4, M5

## Supply Current, ispMACH 4000V/B/C (Cont.)

### Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$I_{CC}^4$	Standby Power Supply Current	Vcc = 3.3V	—	13	—	mA
		Vcc = 2.5V	—	13	—	mA
		Vcc = 1.8V	—	3	—	mA

- 1.  $T_A = 25^\circ\text{C}$ , frequency = 1.0 MHz.
- 2. Device configured with 16-bit counters.
- 3.  $I_{CC}$  varies with specific device configuration and operating frequency.
- 4.  $T_A = 25^\circ\text{C}$

## Supply Current, ispMACH 4000Z

### Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
<b>ispMACH 4032ZC</b>						
$ICC^{1, 2, 3, 5}$	Operating Power Supply Current	Vcc = 1.8V, $T_A = 25^\circ\text{C}$	—	50	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 70^\circ\text{C}$	—	58	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 85^\circ\text{C}$	—	60	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 125^\circ\text{C}$	—	70	—	$\mu\text{A}$
$ICC^{4, 5}$	Standby Power Supply Current	Vcc = 1.8V, $T_A = 25^\circ\text{C}$	—	10	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 70^\circ\text{C}$	—	13	20	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 85^\circ\text{C}$	—	15	25	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 125^\circ\text{C}$	—	22	—	$\mu\text{A}$
<b>ispMACH 4064ZC</b>						
$ICC^{1, 2, 3, 5}$	Operating Power Supply Current	Vcc = 1.8V, $T_A = 25^\circ\text{C}$	—	80	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 70^\circ\text{C}$	—	89	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 85^\circ\text{C}$	—	92	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 125^\circ\text{C}$	—	109	—	$\mu\text{A}$
$ICC^{4, 5}$	Standby Power Supply Current	Vcc = 1.8V, $T_A = 25^\circ\text{C}$	—	11	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 70^\circ\text{C}$	—	15	25	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 85^\circ\text{C}$	—	18	35	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 125^\circ\text{C}$	—	37	—	$\mu\text{A}$
<b>ispMACH 4128ZC</b>						
$ICC^{1, 2, 3, 5}$	Operating Power Supply Current	Vcc = 1.8V, $T_A = 25^\circ\text{C}$	—	168	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 70^\circ\text{C}$	—	190	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 85^\circ\text{C}$	—	195	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 125^\circ\text{C}$	—	212	—	$\mu\text{A}$
$ICC^{4, 5}$	Standby Power Supply Current	Vcc = 1.8V, $T_A = 25^\circ\text{C}$	—	12	—	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 70^\circ\text{C}$	—	16	35	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 85^\circ\text{C}$	—	19	50	$\mu\text{A}$
		Vcc = 1.9V, $T_A = 125^\circ\text{C}$	—	42	—	$\mu\text{A}$

**ispMACH 4000Z External Switching Characteristics (Cont.)****Over Recommended Operating Conditions**

Parameter	Description <sup>1, 2, 3</sup>	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	5-PT bypass combinatorial propagation delay	—	4.5	—	5.0	—	7.5	ns
t <sub>PD_MG</sub>	20-PT combinatorial propagation delay through macrocell	—	5.8	—	6.0	—	8.0	ns
t <sub>S</sub>	GLB register setup time before clock	2.9	—	3.0	—	4.5	—	ns
t <sub>ST</sub>	GLB register setup time before clock with T-type register	3.1	—	3.2	—	4.7	—	ns
t <sub>SIR</sub>	GLB register setup time before clock, input register path	1.3	—	1.3	—	1.4	—	ns
t <sub>SIRZ</sub>	GLB register setup time before clock with zero hold	2.6	—	2.6	—	2.7	—	ns
t <sub>H</sub>	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t <sub>HT</sub>	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t <sub>HIR</sub>	GLB register hold time after clock, input register path	1.3	—	1.3	—	1.3	—	ns
t <sub>HIRZ</sub>	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t <sub>CO</sub>	GLB register clock-to-output delay	—	3.8	—	4.2	—	4.5	ns
t <sub>R</sub>	External reset pin to output delay	—	7.5	—	7.5	—	9.0	ns
t <sub>RW</sub>	External reset pulse duration	2.0	—	2.0	—	4.0	—	ns
t <sub>PTOE/DIS</sub>	Input to output local product term output enable/disable	—	8.2	—	8.5	—	9.0	ns
t <sub>GPTOE/DIS</sub>	Input to output global product term output enable/disable	—	10.0	—	10.0	—	10.5	ns
t <sub>GOE/DIS</sub>	Global OE input to output enable/disable	—	5.5	—	6.0	—	7.0	ns
t <sub>CW</sub>	Global clock width, high or low	1.8	—	2.0	—	2.8	—	ns
t <sub>GW</sub>	Global gate width low (for low transparent) or high (for high transparent)	1.8	—	2.0	—	2.8	—	ns
t <sub>WIR</sub>	Input register clock width, high or low	1.8	—	2.0	—	2.8	—	ns
f <sub>MAX</sub> <sup>4</sup>	Clock frequency with internal feedback	—	200	—	200	—	168	MHz
f <sub>MAX</sub> (Ext.)	clock frequency with external feedback, [1 / (t <sub>S</sub> + t <sub>CO</sub> )]	—	150	—	139	—	111	MHz

1. Timing numbers are based on default LVCMS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.2.2

2. Measured using standard switching GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

**ispMACH 4000V/B/C Internal Timing Parameters**

Over Recommended Operating Conditions

Parameter	Description	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
$t_{IN}$	Input Buffer Delay	—	0.95	—	1.50	—	2.00	ns
$t_{GOE}$	Global OE Pin Delay	—	4.04	—	6.04	—	7.04	ns
$t_{GCLK\_IN}$	Global Clock Input Buffer Delay	—	1.83	—	2.28	—	3.28	ns
$t_{BUF}$	Delay through Output Buffer	—	1.00	—	1.50	—	1.50	ns
$t_{EN}$	Output Enable Time	—	0.96	—	0.96	—	0.96	ns
$t_{DIS}$	Output Disable Time	—	0.96	—	0.96	—	0.96	ns
<b>Routing/GLB Delays</b>								
$t_{ROUTE}$	Delay through GRP	—	1.51	—	2.26	—	3.26	ns
$t_{MCELL}$	Macrocell Delay	—	1.05	—	1.45	—	1.95	ns
$t_{INREG}$	Input Buffer to Macrocell Register Delay	—	0.56	—	0.96	—	1.46	ns
$t_{FBK}$	Internal Feedback Delay	—	0.00	—	0.00	—	0.00	ns
$t_{PD_b}$	5-PT Bypass Propagation Delay	—	1.54	—	2.24	—	3.24	ns
$t_{PD_i}$	Macrocell Propagation Delay	—	0.94	—	1.24	—	1.74	ns
<b>Register/Latch Delays</b>								
$t_S$	D-Register Setup Time (Global Clock)	1.32	—	1.57	—	1.57	—	ns
$t_{S\_PT}$	D-Register Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
$t_{ST}$	T-Register Setup Time (Global Clock)	1.52	—	1.77	—	1.77	—	ns
$t_{ST\_PT}$	T-Register Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
$t_H$	D-Register Hold Time	1.68	—	2.93	—	3.93	—	ns
$t_{HT}$	T-Register Hold Time	1.68	—	2.93	—	3.93	—	ns
$t_{SIR}$	D-Input Register Setup Time (Global Clock)	1.52	—	1.57	—	1.57	—	ns
$t_{SIR\_PT}$	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
$t_{HIR}$	D-Input Register Hold Time (Global Clock)	0.68	—	1.18	—	1.18	—	ns
$t_{HIR\_PT}$	D-Input Register Hold Time (Product Term Clock)	0.68	—	1.18	—	1.18	—	ns
$t_{COi}$	Register Clock to Output/Feedback MUX Time	—	0.52	—	0.67	—	1.17	ns
$t_{CES}$	Clock Enable Setup Time	2.25	—	2.25	—	2.25	—	ns
$t_{CEH}$	Clock Enable Hold Time	1.88	—	1.88	—	1.88	—	ns
$t_{SL}$	Latch Setup Time (Global Clock)	1.32	—	1.57	—	1.57	—	ns
$t_{SL\_PT}$	Latch Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
$t_{HL}$	Latch Hold Time	1.17	—	1.17	—	1.17	—	ns
$t_{GOi}$	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	—	0.33	ns
$t_{PDLi}$	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.25	—	0.25	—	0.25	ns
$t_{SRi}$	Asynchronous Reset or Set to Output/Feedback MUX Delay	0.28	—	0.28	—	0.28	—	ns
$t_{SRR}$	Asynchronous Reset or Set Recovery Time	1.67	—	1.67	—	1.67	—	ns
<b>Control Delays</b>								
$t_{BCLK}$	GLB PT Clock Delay	—	1.12	—	1.12	—	0.62	ns
$t_{PTCLK}$	Macrocell PT Clock Delay	—	0.87	—	0.87	—	0.87	ns
$t_{BSR}$	GLB PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	ns
$t_{PTSR}$	Macrocell PT Set/Reset Delay	—	2.51	—	3.41	—	3.41	ns

**ispMACH 4000V/B/C Internal Timing Parameters (Cont.)****Over Recommended Operating Conditions**

Parameter	Description	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{GPTOE}$	Global PT OE Delay	—	5.58	—	5.58	—	5.78	ns
$t_{PTOE}$	Macrocell PT OE Delay	—	3.58	—	4.28	—	4.28	ns

Timing v.3.2

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the Timing Model in this data sheet for further details.

**ispMACH 4000V/B/C Timing Adders<sup>1</sup> (Cont.)**

Adder Type	Base Parameter	Description	-5		-75		-10		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
$t_{INDIO}$	$t_{INREG}$	Input register delay	—	1.00	—	1.00	—	1.00	ns
$t_{EXP}$	$t_{MCELL}$	Product term expander delay	—	0.33	—	0.33	—	0.33	ns
$t_{ORP}$	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	ns
$t_{BLA}$	$t_{ROUTE}$	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
<b><math>t_{IOI}</math> Input Adjusters</b>									
LVTTL_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVTTL standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS33_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVCMOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS25_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVCMOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS18_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVCMOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b><math>t_{IOO}</math> Output Adjusters</b>									
LVTTL_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVCMOS33_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVCMOS25_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVCMOS18_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	$t_{BUF}$ , $t_{EN}$	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

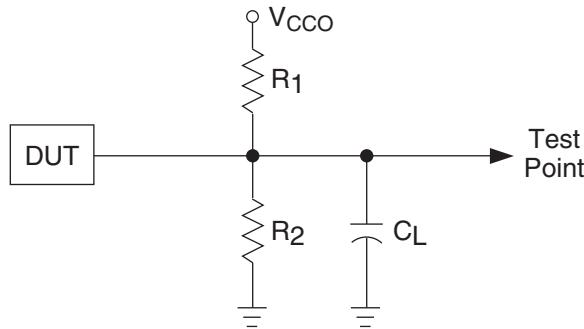
Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

## Switching Test Conditions

Figure 12 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 11.

**Figure 12. Output Test Load, LVTTL and LVC MOS Standards**



0213A/ispm4k

**Table 11. Test Fixture Required Components**

Test Condition	R <sub>1</sub>	R <sub>2</sub>	C <sub>L</sub> <sup>1</sup>	Timing Ref.	V <sub>CCO</sub>
LVC MOS I/O, (L → H, H → L)	106Ω	106Ω	35pF	LVC MOS 3.3 = 1.5V	LVC MOS 3.3 = 3.0V
				LVC MOS 2.5 = V <sub>CCO</sub> /2	LVC MOS 2.5 = 2.3V
				LVC MOS 1.8 = V <sub>CCO</sub> /2	LVC MOS 1.8 = 1.65V
LVC MOS I/O (Z → H)	∞	106Ω	35pF	1.5V	3.0V
LVC MOS I/O (Z → L)	106Ω	∞	35pF	1.5V	3.0V
LVC MOS I/O (H → Z)	∞	106Ω	5pF	V <sub>OH</sub> - 0.3	3.0V
LVC MOS I/O (L → Z)	106Ω	∞	5pF	V <sub>OL</sub> + 0.3	3.0V

1. C<sub>L</sub> includes test fixtures and probe capacitance.

**ispMACH 4000V/B/C/Z Power Supply and NC Connections<sup>1</sup> (Cont.)**

Signal	132-ball csBGA <sup>7</sup>	144-pin TQFP <sup>4</sup>	176-pin TQFP <sup>4</sup>	256-ball ftBGA/fpBGA <sup>2, 3, 7, 9</sup>
VCC	P1, A14, B7, N8	36, 57, 108, 129	42, 69, 88, 130, 157, 176	B2, B15, G8, G9, K8, K9, R2, R15
VCCO0 VCCO (Bank 0)	G3, P5, C1 <sup>8</sup> , M2 <sup>8</sup> , C5	3, 19, 34, 47, 136	4, 22, 40, 56, 166	D6, F4, H7, J7, L4, N6
VCCO1 VCCO (Bank 1)	M10, M14 <sup>8</sup> , H12, A10, C13 <sup>8</sup>	64, 75, 91, 106, 119	78, 92, 110, 128, 144	D11, F13, H10, J10, L13, N11
GND	B1, P2, N14, A13	1, 37, 73, 109	2, 46 <sup>5</sup> , 65, 90, 134, 153	A1, A16, C6, C11, F3, F14, G7, G10, H8, H9, J8, J9, K7, K10, L3, L14, P6, P11, T1, T16
GND (Bank 0)	E2, K2, N4, B4	10, 18 <sup>6</sup> , 27, 46, 127, 137	13, 31, 55, 155, 167	
GND (Bank 1)	N11, K13, E13, B11	55, 65, 82, 90 <sup>6</sup> , 99, 118	67, 79, 101, 119, 143	
NC	<b>4064Z:</b> C1, C3, E1, E3, H2, J3, K1, M2, M4, N5, P7, P8, M8, P10, P11, P14, M12, K14, K12, G13, G14, E14, C13, B13, B10, C10, A7, B5, A5, A4, A1  <b>4128Z:</b> P8, A7	<b>4128V:</b> 17, 20, 38, 45, 72, 89, 92, 110, 117, 144  <b>4256V:</b> 18, 90	1, 43, 44, 45, 89, 131, 132, 133	<b>4256V/B/C, 128 I/O:</b> A4, A5, A6, A11, A12, A13, A15, B5, B6, B11, B12, B14, C7, D1, D4, D5, D10, D12, D16, E1, E2, E4, E5, E7, E10, E13, E14, E15, E16, F1, F2, F15, F16, G1, G4, G5, G6, G12, G13, G14, J11, K3, K4, K15, L1, L2, L12, L15, L16, M1, M2, M3, M4, M5, M12, M13, M15, M16, N1, N2, N7, N10, N12, N14, P5, P12, R4, R5, R6, R11, R12, R16, T2, T4, T5, T6, T11, T12, T13, T15  <b>4256V/B/C, 160 I/O:</b> A5, A12, A15, B5, B6, B11, B12, B14, D4, D5, D12, E1, E4, E5, E13, E15, E16, F1, F2, F15, G1, G5, G12, G14, L1, L2, L12, L15, L16, M1, M2, M3, M12, M16, N1, N12, N14, P5, P12, R4, R5, R6, R11, R12, R16, T4, T5, T12, T15  <b>4384V/B/C:</b> B5, B12, D5, D12, E1, E15, E16, F2, L12, M1, M2, M16, N12, R5, R12, T4  <b>4512V/B/C:</b> None

1. All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.
2. Internal GNDs and I/O GNDs (Bank 0/1) are connected inside package.
3. V<sub>CCO</sub> balls connect to two power planes within the package, one for V<sub>CCO0</sub> and one for V<sub>CCO1</sub>.
4. Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.
5. ispMACH 4384V/B/C pin 46 is tied to GND (Bank 0).
6. ispMACH 4128V only.
7. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.
8. ispMACH 4128Z and 4256Z only. NC for ispMACH 4064Z.
9. Use 256 ftBGA package for all new designs. Refer to PCN#14A-07 for 256 fpBGA package discontinuance.

**ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
K5	0	A15	A^15	B0	B^0
H6	0	CLK1/I	-	CLK1/I	-
K6	1	CLK2/I	-	CLK2/I	-
H7	1	B0	B^0	C0	C^0
K7	1	B1	B^1	C1	C^1
K8	1	B2	B^2	C2	C^2
K9	1	B3	B^3	C4	C^3
K10	1	B4	B^4	C6	C^4
J10	-	TMS	-	TMS	-
H8	1	B5	B^5	C8	C^5
H10	1	B6	B^6	C10	C^6
G10	1	B7	B^7	C11	C^7
G8	1	GND (Bank 1)	-	GND (Bank 1)	-
F8	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
F10	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
E8	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E10	1	B8	B^8	D15	D^7
D8	1	B9	B^9	D12	D^6
D10	1	B10	B^10	D10	D^5
C10	1	B11	B^11	D8	D^4
B10	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
A10	-	TDO	-	TDO	-
A9	-	VCC	-	VCC	-
C8	-	GND	-	GND	-
A8	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
A7	1	B12	B^12	D6	D^3
C7	1	B13	B^13	D4	D^2
C6	1	B14	B^14	D2	D^1
A6	1	B15/GOE1	B^15	D0/GOE1	D^0
C5	1	CLK3/I	-	CLK3/I	-
A5	0	CLK0/I	-	CLK0/I	-
C4	0	A0/GOE0	A^0	A0/GOE0	A^0
A4	0	A1	A^1	A1	A^1
A3	0	A2	A^2	A2	A^2
A2	0	A3	A^3	A4	A^3
A1	0	A4	A^4	A6	A^4

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4064Z devices.

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
105	1	VCCO (Bank 1)	-
106	1	H6	H^5
107	1	H5	H^4
108	1	H4	H^3
109	1	H2	H^2
110	1	H1	H^1
111	1	H0/GOE1	H^0
112	1	CLK3/I	-
113	0	GND (Bank 0)	-
114	0	CLK0/I	-
115	0	VCC	-
116	0	A0/GOE0	A^0
117	0	A1	A^1
118	0	A2	A^2
119	0	A4	A^3
120	0	A5	A^4
121	0	A6	A^5
122	0	VCCO (Bank 0)	-
123	0	GND (Bank 0)	-
124	0	A8	A^6
125	0	A9	A^7
126	0	A10	A^8
127	0	A12	A^9
128	0	A14	A^11

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
B1	-	GND	-	GND	-	GND	-
B2	-	TDI	-	TDI	-	TDI	-
C1	0	NC	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
C3	0	NC	-	B0	B^0	C12	C^6
C2	0	A8	A^8	B1	B^1	C10	C^5
D1	0	A9	A^9	B2	B^2	C8	C^4
D3	0	A10	A^10	B4	B^3	C6	C^3
D2	0	A11	A^11	B5	B^4	C4	C^2
E1	0	NC	-	B6	B^5	C2	C^1
E2	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
E3	0	NC	-	B8	B^6	D12	D^6
F2	0	A12	A^12	B9	B^7	D10	D^5
F1	0	A13	A^13	B10	B^8	D8	D^4
F3	0	A14	A^14	B12	B^9	D6	D^3
G1	0	A15	A^15	B13	B^10	D4	D^2
G2	0	I	-	B14	B^11	D2	D^1
G3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
H2	0	NC	-	C14	C^11	E2	E^1
H1	0	B15	B^15	C13	C^10	E4	E^2
H3	0	B14	B^14	C12	C^9	E6	E^3
J1	0	B13	B^13	C10	C^8	E8	E^4
J2	0	B12	B^12	C9	C^7	E10	E^5
J3	0	NC	-	C8	C^6	E12	E^6
K2	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
K1	0	NC	-	C6	C^5	F2	F^1
K3	0	B11	B^11	C5	C^4	F4	F^2
L2	0	B10	B^10	C4	C^3	F6	F^3
L1	0	B9	B^9	C2	C^2	F8	F^4
L3	0	B8	B^8	C1	C^1	F10	F^5
M1	0	I	-	C0	C^0	F12	F^6
M2	0	NC	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
N1	-	TCK	-	TCK	-	TCK	-
P1	-	VCC	-	VCC	-	VCC	-
P2	-	GND	-	GND	-	GND	-
N2	0	I	-	D14	D^11	G12	G^6
P3	0	B7	B^7	D13	D^10	G10	G^5
M3	0	B6	B^6	D12	D^9	G8	G^4
N3	0	B5	B^5	D10	D^8	G6	G^3
P4	0	B4	B^4	D9	D^7	G4	G^2
M4	0	NC	-	D8	D^6	G2	G^1
N4	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
P5	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
N5	0	NC	-	D6	D^5	H12	H^6
M5	0	B3	B^3	D5	D^4	H10	H^5
N6	0	B2	B^2	D4	D^3	H8	H^4
P6	0	B1	B^1	D2	D^2	H6	H^3
M6	0	B0	B^0	D1	D^1	H4	H^2
P7	0	NC	-	D0	D^0	H2	H^1
N7	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
M7	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
N8	-	VCC	-	VCC	-	VCC	-

**ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V		ispMACH 4256V	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
43	0	D9	D^7	G4	G^2
44	0	D8	D^6	G2	G^1
45	0	NC <sup>2</sup>	-	I <sup>2</sup>	-
46	0	GND (Bank 0)	-	GND (Bank 0)	-
47	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
48	0	D6	D^5	H12	H^6
49	0	D5	D^4	H10	H^5
50	0	D4	D^3	H8	H^4
51	0	D2	D^2	H6	H^3
52	0	D1	D^1	H4	H^2
53	0	D0	D^0	H2	H^1
54	0	CLK1/I	-	CLK1/I	-
55	1	GND (Bank 1)	-	GND (Bank 1)	-
56	1	CLK2/I	-	CLK2/I	-
57	-	VCC	-	VCC	-
58	1	E0	E^0	I2	I^1
59	1	E1	E^1	I4	I^2
60	1	E2	E^2	I6	I^3
61	1	E4	E^3	I8	I^4
62	1	E5	E^4	I10	I^5
63	1	E6	E^5	I12	I^6
64	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
65	1	GND (Bank 1)	-	GND (Bank 1)	-
66	1	E8	E^6	J2	J^1
67	1	E9	E^7	J4	J^2
68	1	E10	E^8	J6	J^3
69	1	E12	E^9	J8	J^4
70	1	E13	E^10	J10	J^5
71	1	E14	E^11	J12	J^6
72	1	NC <sup>2</sup>	-	I <sup>2</sup>	-
73	-	GND	-	GND	-
74	-	TMS	-	TMS	-
75	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
76	1	F0	F^0	K12	K^6
77	1	F1	F^1	K10	K^5
78	1	F2	F^2	K8	K^4
79	1	F4	F^3	K6	K^3
80	1	F5	F^4	K4	K^2
81	1	F6	F^5	K2	K^1
82	1	GND (Bank 1)	-	GND (Bank 1)	-
83	1	F8	F^6	L14	L^7
84	1	F9	F^7	L12	L^6
85	1	F10	F^8	L10	L^5

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
60	0	H8	H^4	L8	L^4	P8	P^4
61	0	H6	H^3	L6	L^3	P6	P^3
62	0	H4	H^2	L4	L^2	P4	P^2
63	0	H2	H^1	L2	L^1	P2	P^1
64	0	H0	H^0	L0	L^0	P0	P^0
65	-	GND	-	GND	-	GND	-
66	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
67	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
68	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
69	-	VCC	-	VCC	-	VCC	-
70	1	I0	I^0	M0	M^0	AX0	AX^0
71	1	I2	I^1	M2	M^1	AX2	AX^1
72	1	I4	I^2	M4	M^2	AX4	AX^2
73	1	I6	I^3	M6	M^3	AX6	AX^3
74	1	I8	I^4	M8	M^4	AX8	AX^4
75	1	I10	I^5	M10	M^5	AX10	AX^5
76	1	I12	I^6	M12	M^6	AX12	AX^6
77	1	I14	I^7	M14	M^7	AX14	AX^7
78	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
79	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
80	1	J0	J^0	N0	N^0	BX0	BX^0
81	1	J2	J^1	N2	N^1	BX2	BX^1
82	1	J4	J^2	N4	N^2	BX4	BX^2
83	1	J6	J^3	N6	N^3	BX6	BX^3
84	1	J8	J^4	N8	N^4	BX8	BX^4
85	1	J10	J^5	N10	N^5	BX10	BX^5
86	1	J12	J^6	N12	N^6	BX12	BX^6
87	1	J14	J^7	N14	N^7	BX14	BX^7
88	-	VCC	-	VCC	-	VCC	-
89	-	NC	-	NC	-	NC	-
90	-	GND	-	GND	-	GND	-
91	-	TMS	-	TMS	-	TMS	-
92	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
93	1	K14	K^7	O14	O^7	CX14	CX^7
94	1	K12	K^6	O12	O^6	CX12	CX^6
95	1	K10	K^5	O10	O^5	CX10	CX^5
96	1	K8	K^4	O8	O^4	CX8	CX^4
97	1	K6	K^3	O6	O^3	CX6	CX^3
98	1	K4	K^2	O4	O^2	CX4	CX^2
99	1	K2	K^1	O2	O^1	CX2	CX^1
100	1	K0	K^0	O0	O^0	CX0	CX^0

**Lead-Free Packaging****ispMACH 4000Z (Zero Power, 1.8V) Lead-Free Commercial Devices**

<b>Device</b>	<b>Part Number</b>	<b>Macrocells</b>	<b>Voltage</b>	<b>t<sub>PD</sub></b>	<b>Package</b>	<b>Pin/Ball Count</b>	<b>I/O</b>	<b>Grade</b>
LC4032ZC	LC4032ZC-35MN56C	32	1.8	3.5	Lead-free csBGA	56	32	C
	LC4032ZC-5MN56C	32	1.8	5	Lead-free csBGA	56	32	C
	LC4032ZC-75MN56C	32	1.8	7.5	Lead-free csBGA	56	32	C
	LC4032ZC-35TN48C	32	1.8	3.5	Lead-free TQFP	48	32	C
	LC4032ZC-5TN48C	32	1.8	5	Lead-free TQFP	48	32	C
	LC4032ZC-75TN48C	32	1.8	7.5	Lead-free TQFP	48	32	C
LC4064ZC	LC4064ZC-37MN132C	64	1.8	3.7	Lead-free csBGA	132	64	C
	LC4064ZC-5MN132C	64	1.8	5	Lead-free csBGA	132	64	C
	LC4064ZC-75MN132C	64	1.8	7.5	Lead-free csBGA	132	64	C
	LC4064ZC-37TN100C	64	1.8	3.7	Lead-free TQFP	100	64	C
	LC4064ZC-5TN100C	64	1.8	5	Lead-free TQFP	100	64	C
	LC4064ZC-75TN100C	64	1.8	7.5	Lead-free TQFP	100	64	C
	LC4064ZC-37MN56C	64	1.8	3.7	Lead-free csBGA	56	32	C
	LC4064ZC-5MN56C	64	1.8	5	Lead-free csBGA	56	32	C
	LC4064ZC-75MN56C	64	1.8	7.5	Lead-free csBGA	56	32	C
	LC4064ZC-37TN48C	64	1.8	3.7	Lead-free TQFP	48	32	C
	LC4064ZC-5TN48C	64	1.8	5	Lead-free TQFP	48	32	C
	LC4064ZC-75TN48C	64	1.8	7.5	Lead-free TQFP	48	32	C
LC4128ZC	LC4128ZC-42MN132C	128	1.8	4.2	Lead-free csBGA	132	96	C
	LC4128ZC-75MN132C	128	1.8	7.5	Lead-free csBGA	132	96	C
	LC4128ZC-42TN100C	128	1.8	4.2	Lead-free TQFP	100	64	C
	LC4128ZC-75TN100C	128	1.8	7.5	Lead-free TQFP	100	64	C
LC4256ZC	LC4256ZC-45TN176C	256	1.8	4.5	Lead-free TQFP	176	128	C
	LC4256ZC-75TN176C	256	1.8	7.5	Lead-free TQFP	176	128	C
	LC4256ZC-45MN132C	256	1.8	4.5	Lead-free csBGA	132	96	C
	LC4256ZC-75MN132C	256	1.8	7.5	Lead-free csBGA	132	96	C
	LC4256ZC-45TN100C	256	1.8	4.5	Lead-free TQFP	100	64	C
	LC4256ZC-75TN100C	256	1.8	7.5	Lead-free TQFP	100	64	C

**ispMACH 4000Z (Zero Power, 1.8V) Lead-Free Industrial Devices**

<b>Device</b>	<b>Part Number</b>	<b>Macrocells</b>	<b>Voltage</b>	<b>t<sub>PD</sub></b>	<b>Package</b>	<b>Pin/Ball Count</b>	<b>I/O</b>	<b>Grade</b>
LC4032ZC	LC4032ZC-5MN56I	32	1.8	5	Lead-free csBGA	56	32	I
	LC4032ZC-75MN56I	32	1.8	7.5	Lead-free csBGA	56	32	I
	LC4032ZC-5TN48I	32	1.8	5	Lead-free TQFP	48	32	I
	LC4032ZC-75TN48I	32	1.8	7.5	Lead-free TQFP	48	32	I

## ispMACH 4000C (1.8V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4064C	LC4064C-25TN100C	64	1.8	2.5	Lead-free TQFP	100	64	C
	LC4064C-5TN100C	64	1.8	5	Lead-free TQFP	100	64	C
	LC4064C-75TN100C	64	1.8	7.5	Lead-free TQFP	100	64	C
	LC4064C-25TN48C	64	1.8	2.5	Lead-free TQFP	48	32	C
	LC4064C-5TN48C	64	1.8	5	Lead-free TQFP	48	32	C
	LC4064C-75TN48C	64	1.8	7.5	Lead-free TQFP	48	32	C
	LC4064C-25TN44C	64	1.8	2.5	Lead-free TQFP	44	30	C
	LC4064C-5TN44C	64	1.8	5	Lead-free TQFP	44	30	C
	LC4064C-75TN44C	64	1.8	7.5	Lead-free TQFP	44	30	C
LC4128C	LC4128C-27TN128C	128	1.8	2.7	Lead-free TQFP	128	92	C
	LC4128C-5TN128C	128	1.8	5	Lead-free TQFP	128	92	C
	LC4128C-75TN128C	128	1.8	7.5	Lead-free TQFP	128	92	C
	LC4128C-27TN100C	128	1.8	2.7	Lead-free TQFP	100	64	C
	LC4128C-5TN100C	128	1.8	5	Lead-free TQFP	100	64	C
	LC4128C-75TN100C	128	1.8	7.5	Lead-free TQFP	100	64	C
LC4256C	LC4256C-3FTN256AC	256	1.8	3	Lead-free ftBGA	256	128	C
	LC4256C-5FTN256AC	256	1.8	5	Lead-free ftBGA	256	128	C
	LC4256C-75FTN256AC	256	1.8	7.5	Lead-free ftBGA	256	128	C
	LC4256C-3FTN256BC	256	1.8	3	Lead-free ftBGA	256	160	C
	LC4256C-5FTN256BC	256	1.8	5	Lead-free ftBGA	256	160	C
	LC4256C-75FTN256BC	256	1.8	7.5	Lead-free ftBGA	256	160	C
	LC4256C-3FN256AC <sup>1</sup>	256	1.8	3	Lead-free fpBGA	256	128	C
	LC4256C-5FN256AC <sup>1</sup>	256	1.8	5	Lead-free fpBGA	256	128	C
	LC4256C-75FN256AC <sup>1</sup>	256	1.8	7.5	Lead-free fpBGA	256	128	C
	LC4256C-3FN256BC <sup>1</sup>	256	1.8	3	Lead-free fpBGA	256	160	C
	LC4256C-5FN256BC <sup>1</sup>	256	1.8	5	Lead-free fpBGA	256	160	C
	LC4256C-75FN256BC <sup>1</sup>	256	1.8	7.5	Lead-free fpBGA	256	160	C
	LC4256C-3TN176C	256	1.8	3	Lead-free TQFP	176	128	C
	LC4256C-5TN176C	256	1.8	5	Lead-free TQFP	176	128	C
	LC4256C-75TN176C	256	1.8	7.5	Lead-free TQFP	176	128	C
	LC4256C-3TN100C	256	1.8	3	Lead-free TQFP	100	64	C
	LC4256C-5TN100C	256	1.8	5	Lead-free TQFP	100	64	C
	LC4256C-75TN100C	256	1.8	7.5	Lead-free TQFP	100	64	C
LC4384C	LC4384C-35FTN256C	384	1.8	3.5	Lead-free ftBGA	256	192	C
	LC4384C-5FTN256C	384	1.8	5	Lead-free ftBGA	256	192	C
	LC4384C-75FTN256C	384	1.8	7.5	Lead-free ftBGA	256	192	C
	LC4384C-35FN256C <sup>1</sup>	384	1.8	3.5	Lead-free fpBGA	256	192	C
	LC4384C-5FN256C <sup>1</sup>	384	1.8	5	Lead-free fpBGA	256	192	C
	LC4384C-75FN256C <sup>1</sup>	384	1.8	7.5	Lead-free fpBGA	256	192	C
	LC4384C-35TN176C	384	1.8	3.5	Lead-free TQFP	176	128	C
	LC4384C-5TN176C	384	1.8	5	Lead-free TQFP	176	128	C
	LC4384C-75TN176C	384	1.8	7.5	Lead-free TQFP	176	128	C

## ispMACH 4000B (2.5V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032B	LC4032B-25TN48C	32	2.5	2.5	Lead-Free TQFP	48	32	C
	LC4032B-5TN48C	32	2.5	5	Lead-Free TQFP	48	32	C
	LC4032B-75TN48C	32	2.5	7.5	Lead-Free TQFP	48	32	C
	LC4032B-25TN44C	32	2.5	2.5	Lead-Free TQFP	44	30	C
	LC4032B-5TN44C	32	2.5	5	Lead-Free TQFP	44	30	C
	LC4032B-75TN44C	32	2.5	7.5	Lead-Free TQFP	44	30	C
LC4064B	LC4064B-25TN100C	64	2.5	2.5	Lead-Free TQFP	100	64	C
	LC4064B-5TN100C	64	2.5	5	Lead-Free TQFP	100	64	C
	LC4064B-75TN100C	64	2.5	7.5	Lead-Free TQFP	100	64	C
	LC4064B-25TN48C	64	2.5	2.5	Lead-Free TQFP	48	32	C
	LC4064B-5TN48C	64	2.5	5	Lead-Free TQFP	48	32	C
	LC4064B-75TN48C	64	2.5	7.5	Lead-Free TQFP	48	32	C
	LC4064B-25TN44C	64	2.5	2.5	Lead-Free TQFP	44	30	C
	LC4064B-5TN44C	64	2.5	5	Lead-Free TQFP	44	30	C
	LC4064B-75TN44C	64	2.5	7.5	Lead-Free TQFP	44	30	C
LC4128B	LC4128B-27TN128C	128	2.5	2.7	Lead-Free TQFP	128	92	C
	LC4128B-5TN128C	128	2.5	5	Lead-Free TQFP	128	92	C
	LC4128B-75TN128C	128	2.5	7.5	Lead-Free TQFP	128	92	C
	LC4128B-27TN100C	128	2.5	2.7	Lead-Free TQFP	100	92	C
	LC4128B-5TN100C	128	2.5	5	Lead-Free TQFP	100	92	C
	LC4128B-75TN100C	128	2.5	7.5	Lead-Free TQFP	100	92	C
LC4256B	LC4256B-3FTN256AC	256	2.5	3	Lead-Free ftBGA	256	128	C
	LC4256B-5FTN256AC	256	2.5	5	Lead-Free ftBGA	256	128	C
	LC4256B-75FTN256AC	256	2.5	7.5	Lead-Free ftBGA	256	128	C
	LC4256B-3FTN256BC	256	2.5	3	Lead-Free ftBGA	256	160	C
	LC4256B-5FTN256BC	256	2.5	5	Lead-Free ftBGA	256	160	C
	LC4256B-75FTN256BC	256	2.5	7.5	Lead-Free ftBGA	256	160	C
	LC4256B-3FN256AC <sup>1</sup>	256	2.5	3	Lead-Free fpBGA	256	128	C
	LC4256B-5FN256AC <sup>1</sup>	256	2.5	5	Lead-Free fpBGA	256	128	C
	LC4256B-75FN256AC <sup>1</sup>	256	2.5	7.5	Lead-Free fpBGA	256	128	C
	LC4256B-3FN256BC <sup>1</sup>	256	2.5	3	Lead-Free fpBGA	256	160	C
	LC4256B-5FN256BC <sup>1</sup>	256	2.5	5	Lead-Free fpBGA	256	160	C
	LC4256B-75FN256BC <sup>1</sup>	256	2.5	7.5	Lead-Free fpBGA	256	160	C
	LC4256B-3TN176C	256	2.5	3	Lead-Free TQFP	176	128	C
	LC4256B-5TN176C	256	2.5	5	Lead-Free TQFP	176	128	C
	LC4256B-75TN176C	256	2.5	7.5	Lead-Free TQFP	176	128	C
	LC4256B-3TN100C	256	2.5	3	Lead-Free TQFP	100	64	C
	LC4256B-5TN100C	256	2.5	5	Lead-Free TQFP	100	64	C
	LC4256B-75TN100C	256	2.5	7.5	Lead-Free TQFP	100	64	C

## ispMACH 4000V (3.3V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-25TN48C	32	3.3	2.5	Lead-free TQFP	48	32	C
	LC4032V-5TN48C	32	3.3	5	Lead-free TQFP	48	32	C
	LC4032V-75TN48C	32	3.3	7.5	Lead-free TQFP	48	32	C
	LC4032V-25TN44C	32	3.3	2.5	Lead-free TQFP	44	30	C
	LC4032V-5TN44C	32	3.3	5	Lead-free TQFP	44	30	C
	LC4032V-75TN44C	32	3.3	7.5	Lead-free TQFP	44	30	C
LC4064V	LC4064V-25TN100C	64	3.3	2.5	Lead-free TQFP	100	64	C
	LC4064V-5TN100C	64	3.3	5	Lead-free TQFP	100	64	C
	LC4064V-75TN100C	64	3.3	7.5	Lead-free TQFP	100	64	C
	LC4064V-25TN48C	64	3.3	2.5	Lead-free TQFP	48	32	C
	LC4064V-5TN48C	64	3.3	5	Lead-free TQFP	48	32	C
	LC4064V-75TN48C	64	3.3	7.5	Lead-free TQFP	48	32	C
	LC4064V-25TN44C	64	3.3	2.5	Lead-free TQFP	44	30	C
	LC4064V-5TN44C	64	3.3	5	Lead-free TQFP	44	30	C
	LC4064V-75TN44C	64	3.3	7.5	Lead-free TQFP	44	30	C
LC4128V	LC4128V-27TN144C	128	3.3	2.7	Lead-free TQFP	144	96	C
	LC4128V-5TN144C	128	3.3	5	Lead-free TQFP	144	96	C
	LC4128V-75TN144C	128	3.3	7.5	Lead-free TQFP	144	96	C
	LC4128V-27TN128C	128	3.3	2.7	Lead-free TQFP	128	92	C
	LC4128V-5TN128C	128	3.3	5	Lead-free TQFP	128	92	C
	LC4128V-75TN128C	128	3.3	7.5	Lead-free TQFP	128	92	C
	LC4128V-27TN100C	128	3.3	2.7	Lead-free TQFP	100	64	C
	LC4128V-5TN100C	128	3.3	5	Lead-free TQFP	100	64	C
	LC4128V-75TN100C	128	3.3	7.5	Lead-free TQFP	100	64	C

## ispMACH 4000V (3.3V) Lead-Free Extended Temperature Devices

Device	Part Number	Macrocells	Voltage	$t_{PD}$	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75TN48E	32	3.3	7.5	Lead-free TQFP	48	32	E
	LC4032V-75TN44E	32	3.3	7.5	Lead-free TQFP	44	30	E
LC4064V	LC4064V-75TN100E	64	3.3	7.5	Lead-free TQFP	100	64	E
	LC4064V-75TN48E	64	3.3	7.5	Lead-free TQFP	48	32	E
	LC4064V-75TN44E	64	3.3	7.5	Lead-free TQFP	44	30	E
LC4128V	LC4128V-75TN144E	128	3.3	7.5	Lead-free TQFP	144	96	E
	LC4128V-75TN128E	128	3.3	7.5	Lead-free TQFP	128	92	E
	LC4128V-75TN100E	128	3.3	7.5	Lead-free TQFP	100	64	E
LC4256V	LC4256V-75TN176E	256	3.3	7.5	Lead-free TQFP	176	128	E
	LC4256V-75TN144E	256	3.3	7.5	Lead-free TQFP	144	96	E
	LC4256V-75TN100E	256	3.3	7.5	Lead-free TQFP	100	64	E

**For Further Information**

In addition to this data sheet, the following technical notes may be helpful when designing with the ispMACH 4000V/B/C/Z family:

- TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#)
- TN1005, [Power Estimation in ispMACH 4000V/B/C/Z Devices](#)

**Revision History**

Date	Version	Change Summary
—	—	Previous Lattice releases.
July 2003	17z	Changed device status for LC4064ZC and LC4128ZC to production release and updated/added AC and DC parameters as well as ordering part numbers for LC4064ZC and LC4128ZC devices.
		Improved leakage current specifications for ispMACH 4000Z. For ispMACH 4000V/B/C IIL, IIH condition now includes 0V and 3.6V end points ( $0 \leq V_{IN} \leq 3.6V$ ).
		Added 132-ball chip scale BGA power supply and NC connections.
		Added 132-ball chip scale BGA logic signal connections for LC4064ZC, LC4128ZC and LC4256ZC devices.
		Added lead-free package designators.
October 2003	18z	Hot socketing characteristics footnote 1. has been enhanced; Insensitive to sequence of VCC or VCCO. However, assumes monotonic rise/fall rates for Vcc and Vcco, provided $(V_{IN} - VCCO) \leq 3.6V$ .
		Improved LC4064ZC $t_S$ to 2.5ns, $t_{ST}$ to 2.7ns and $f_{MAX}$ (Ext.) to 175MHz, LC4128ZC $t_{CO}$ to 3.5ns and $f_{MAX}$ (Ext.) to 161MHz (version v.2.1).
		Improved associated internal timing numbers and timing adders (version v.2.1).
		Added ispMACH 4000V/B/C/Z ORP Reference Tables.
		Enhanced ORP information in device pinout tables consistent with the ORP Combinations for I/O Blocks tables (table 6, 7, 8 and 9 in page 9-11).
		Corrected GLB/MC/Pad information in the 256-fpBGA pinouts for the LC4256V/B/C 160-I/O version.
		Added the ispMACH 4000 Family Speed Grade Offering table.
		Added the ispMACH 4128ZC Industrial and Automotive Device OPNs
December 2003	19z	Added the ispMACH 4032ZC and 4064ZC Industrial and Automotive Device OPNs

## Revision History (Cont.)

Date	Version	Change Summary
January 2004	20z	ispMACH 4000Z data sheet status changed from preliminary to final. Documents production release of the ispMACH 4256Z device.
		Added new feature - ispMACH 4000Z supports operation down to 1.6V.
		Added lead-free packaging ordering part numbers for the ispMACH 4000Z/C/V devices.
April 2004	21z	Updated $I_{PU}$ (I/O Weak Pull-up Resistor Current) max. specification for the ispMACH 4000V/B/C; -150 $\mu$ A to -200 $\mu$ A.
November 2004	22z	Added User Electronic Signature section.
		Added ispMACH 4000B (2.5V) Lead-Free Ordering Part Numbers.
December 2004	22z.1	Updated Further Information section.
February 2006	22z.2	Clarification to ispMACH 4000Z Input Leakage ( $I_{IH}$ ) specification.
March 2007	22.3	Updated ispMACH 4000 Introduction section.
		Updated Signal Descriptions table.
June 2007	22.4	Updated Features bullets to include reference to "LA" automotive data sheet under the "Broad Device Offering" bullet.
		Added footnote 1 to Part Number Description to reference the "LA" automotive data sheet.
		Changed device temperature references from 'Automotive' to "Extended Temperature" for non-AEC-Q100 qualified devices.
November 2007	23.0	Added 256-ftBGA package Ordering Part Number information per PCN#14A-07.
May 2009	23.1	Correction to $t_{CW}$ , $t_{GW}$ , $t_{WIR}$ and $f_{MAX}$ parameters in ispMACH 4000Z External Switching Characteristics table.
		Correction to $t_{CW}$ , $t_{GW}$ , $t_{WIR}$ and $f_{MAX}$ parameters in ispMACH 4000V/B/C External Switching Characteristics table.